OP \$40.00 1232

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ji Ho HONG	11/24/2008

RECEIVING PARTY DATA

Name:	Dongbu HiTek Co., Ltd.
Street Address:	891-10 Daechi-dong, Gangnam-gu
City:	Seoul
State/Country:	KOREA, REPUBLIC OF
Postal Code:	135-280

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12325082

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	SPO200805-0198US	
NAME OF SUBMITTER:	Andrew D. Fortney, Reg. No. 34,600	

Total Attachments: 1

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PATENT REEL: 021899 FRAME: 0516 Attorney Docket No.: SPO200805-0198US

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, i, the undersigned, \mathbf{Ji} **Ho HONG**

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled;

Semiconductor Device and Method of Fabricating the Same

· · · · · · · · · · · · · · · · · · ·	
Do hereby sell, assign and transfer to Dongbu HiTek Co., Ltd. of Republic of Korea at 891-16, Daechi-dong, Ganguam-gu, Seoul 135-280 / Republic of Korea its successors, assigns, and legal representatives, the full and exclusive right application and to any and all inventions described in said application for the possessions and all foreign countries, and the entire right, title and interest in and which may be granted therefor in the United States, its territorial possessions and and to any and all continuations-in-part, continuations, divisions, substitutes, reissue other applications for Letters Patent relating thereto which have been or shall be it territorial possessions and/or any foreign countries, and all rights, together with all the international conventions, unions, agreements, acts, and treaties, including all agreements, acts, and treaties;	United States, its territorial to any and all Letters Patent all foreign countries; and in es, extensions thereof, and all filed in the United States, its priority rights, under any of
	I foreign countries; and that, ment, at the expense of said execute all continuations-in- rightful oaths, assignments, dings; communicate to said undersigned relating to said aid Assignee, its successors, taining and enforcing proper
Covenant with said Assignee, its successors, assigns, or legal representatives mortgage, license or other agreement affecting the rights and property herein converse by the undersigned, and that full right to convey the same as herein expressed is possible.	yed has been made to others sessed by the undersigned.
IN TESTIMONY WHEREOF I have hereunto set MY signature on the date indicate	ed below.
Full Name of Sole/First Inventor: Ji Ho HONG	
Inventor's Signature: Date: Month Nove	/Day/Year ember / 24 /2mof
Fuli Name of Second Inventor, if any:	
Inventor's Signature: Date: Month	/Day/Year
the state of the s	

Customer No. 36872